IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Pate	ent App	olication of:				
Mitsuru Ik	KEDA,	et al.				
Application	n No.:		Group Art Unit:			
Filed: Fe	bruary	12, 2004	Examiner:			
For: MI	ETHO	D AND APPARATUS FOR GENER	ATING DATA FOR MACHINING			
		INFORMATION DISCLO	SURE STATEMENT			
PO Box 1	450	for Patents 22313-1450				
Sir:						
provided the subject	certair ct U.S.	information which the Examiner m	rovisions of 37 CFR § 1.56, there is hereby any consider material to the examination of that the Examiner make this information of the subject application.			
1.	E	Enclosures accompanying this Infor	osures accompanying this Information Disclosure Statement are:			
	1a. [2 1b. [2 1c. [1d. [2 1e. [Copies of IDS citations. An English language copy of sapplication or a PCT Internation English language translation (deach non-English language put Explanations of Relevancy of I	complete or relevant portion(s)) attached to			
2. In accordance with 37 CFR § 1.98, a concise explanation of what is presently understood to be the relevance of each non-English language publication is						
	2a. [enclosed "English-language ve indicates the degree of relevar 609, Minimum Requirements f A(3): Concise Explanation of F Feb. 2000.)	s 2a, 2b, 2c and/or 2d) sh language publications were cited on the ersion of the search report or action which note found by the foreign office". (See MPEP or an Information Disclosure Statement, Part Relevance, pp. 600-100 to 600-101, Rev. 1,			
	2b.	set forth in the application.				

	2c. ½	_	satistied becau portion(s)) is a enclosed as A	ttached to	each non	-English	, ,	plication.	ι
3.	to be (othe	e, ma er tha	terial to patent in search repo	tability nor rt(s) from a	a represe a counter _l	entation to part forei	hat a search l ign applicatior	is, or is consident has been made n or a PCT .97(g) and (h).	9
				F	Respectfu	lly subm	itted,		
					STAAS &	HALSEY	/ LLP		
Dated: F 1201 New Washington Telephone Facsimile	v York on, D.0 e: (202	Ave. C. 20 2) 43	, N.W., Suite 7 0005 4-1500	70 0	Ву:	H. J. St Registra	ation No. 22,0	<u>110</u>	

FORM PTO-1449

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE

ATTORNEY DOCKET NO.

1538.1047

FIRST NAMED INVENTOR

LIST OF REFERENCES CITED BY APPLICANT

(Use several sheets if necessary)

FIRST NAMED INVENTOR							
Mitsuru IKEDA, et al.							
FILING DATE	GROUP ART UNIT						
February 12, 2004	Oncor Anti-onti-						

U.S. PATENT DOCUMENTS

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EXAMINER INITIAL		DOCUMENT NO.	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
	AA						
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FOREIGN PATENT DOCUMENTS

	DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB- CLASS	TRANSI YES	
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АН							
Al	•						
AJ							
AK	:						
AL							

OTHER REFERENCES (INCLUDING AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.)

	AM	Iwata, Shinji, "Module to estimate cutting resisting power", Die and Mould Technology Conference of the Japanese Society of Die and Mould Technology 2001, June 24, 2001, pages 200-201.
	AN	Choi, Byoung K., "Sculptured Surface Machining Theory and Applications", Kluwer Academic Publishers, January 1999, Chapter 7.
	AO	

		
EXAMINER		DATE CONSIDERED

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.